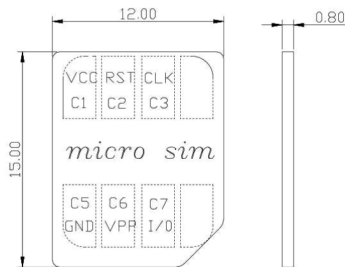


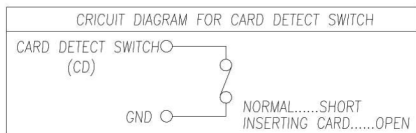
SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

**NOTES:**  
**MATERIAL:**  
 Insulator: High Temperature Thermoplastic,UL 94V-0.  
 Contact: Copper Alloy  
 Shell: STAINLESS  
**PLATING:**  
 Contact: Plated 30u'' Ni Overall Contact Au IU  
 Shell: Plated 30u'' Ni Overall  
 Plated 1u''Au Selective Contact Area  
**Electrical:**  
 Current Rating :0.5mA AC/DC max.  
 Voltage Rating :125V AC/DC  
 Ambient Temperature Range :-20° C~+60° C  
 Storage Temperature Range :-40° C~+70° C  
 Ambient Humidity Range :95% R.H. Max.  
 Contact Resistance:100mΩmax.  
 Insulation Resistance:1000MΩmin./500VDC  
 Mating Cycles:10000 Insertions  
 Temperature: 260° C ±5°



MICRO SIM CARD

■ CIRCUIT TRACE KEEP OUT AREA  
 ■ SMT SOLDER AREA  
 THERE SHOULD NOT BE ANY CIRCUITRIES  
 IN THE LAYOUT SPACE OF THE PRODUCTS.  
RECOMMENDED PCB LAYOUT  
 GENERAL TOLERANCE ±0.05



KH-SIM1616-6PIN		DATE 2014/5/27
TOLERANCE UNSPECIFIED	TITLE 产品名称 MICRO SIM PUSH 6P	UNIT 单位 (mm)
X. ±0.30 X. ±3°	PART NUMBER 产品料号 C3P206J2640	DESIGNED 设计 罗正富
.X ±0.25 .X ±2°	DRAWING NUMBER 图纸编号	CHECKED 核准 罗利斌
.XX ±0.20 .XX ±1°		SHEET 页码 1/1
.XXX ±0.05 .XXX ±0.5°		APPROVED 审核 张华宇